

Applicant : Ralph Beyer et al.  
For : LARGE PACKAGE FOR THE TRANSPORT AND STORAGE OF  
INSULATION ELEMENTS AND COMBINED IN MODULES  
THEREFOR  
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REMARKS

Applicants have attempted to place the claims and specification into conformity with the United States patent claim and application format. Applicants therefore respectfully submit that all pending claims are in condition for allowance, and a Notice to this effect is earnestly solicited.

Respectfully submitted,

10/13/05  
Date

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